

In Application of:

O'Brien, et al.

Application No.: 10/814,592

Filed: March 31, 2004

Confirmation No.: 5877

For: CAPPING OF COPPER

STRUCTURES IN

HYDROPHOBIC ILD USING AQUEOUS ELECTRO-LESS

**BATH** 

Examiner: Berry, Renee R.

Group Art Unit: 2818

Customer No.: 31,817

## **CERTIFICATE OF TRANSMISSION/MAILING**

I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313-1450 on this date: October 10, 2005

Typed or Rrinted: Yvette L. Chriscade

Signature:

Mail Stop Amendment Commissioner for Patents PO Box 1450 Alexandria, VA 22313-1450

## RESPONSE TO NOTICE OF NONCOMPLIANT AMENDMENT

To The Commissioner for Patents:

In response to the Notice of Non-Compliant Amendment mailed April 28, 2005, applicant submits the following response.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.

10/18/2005 BABRAHA1 00000004 10814592

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